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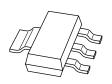
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PBHV8215Z150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistorRev. 01 — 11 November 2009Product data

Product data sheet

Product profile 1.

1.1 General description

NPN high-voltage low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a medium power SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

PNP complement: PBHV9215Z.

1.2 Features

- High voltage
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- AEC-Q101 qualified
- Medium power SMD plastic package

1.3 Applications

- LED driver for LED chain module
- LCD backlighting
- Automotive motor management
- Switch Mode Power Supply (SMPS)

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	150	V
I _C	collector current		-	-	2	А
h _{FE}	DC current gain	V _{CE} = 10 V; I _C = 100 mA	<u>[1]</u> 100	240	-	

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.



150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	collector		2, 4
3	emitter		1
4	collector		`` ``
			3
			sym016

3. Ordering information

Table 3. Orde	ring informati	on	
Type number	Package		
	Name	Description	Version
PBHV8215Z	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223

4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
PBHV821	52	V8215Z

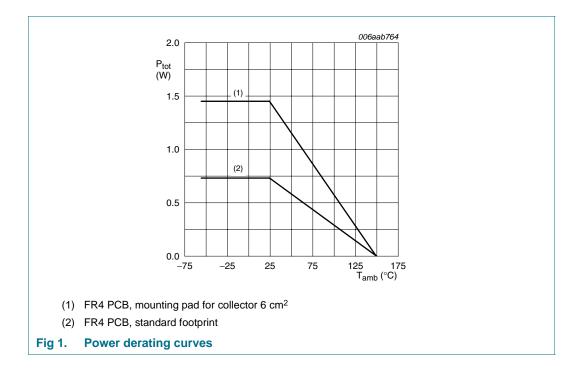
150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

5. Limiting values

Table 5. In accorda	Limiting values nce with the Absolute Maximu	m Rating System (IE	C 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	350	V
V _{CEO}	collector-emitter voltage	open base	-	150	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	2	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	4	A
I _{BM}	peak base current	single pulse; $t_p \leq 1 ms$	-	500	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	0.73	W
			[2] _	1.45	W
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm².



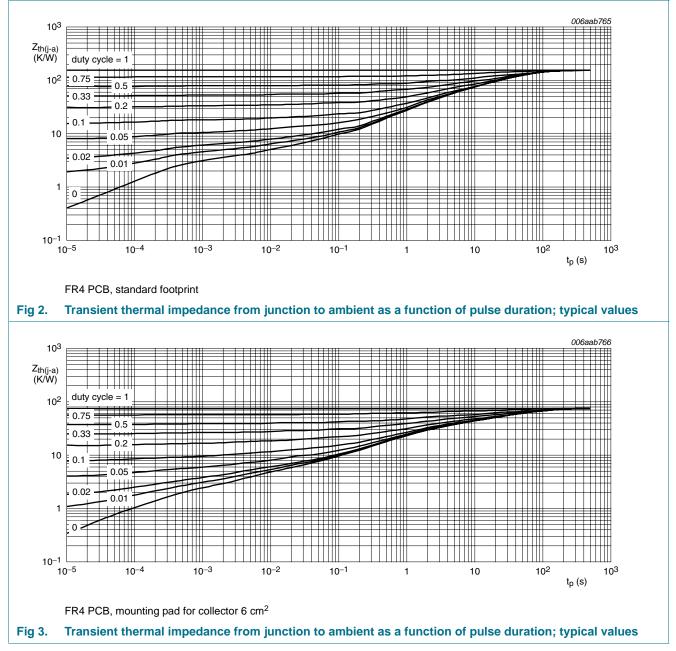
150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	<u>[1]</u> -	-	170	K/W
	junction to ambient		[2] _	-	85	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	15	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm².



PBHV8215Z_1

150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

7. Characteristics

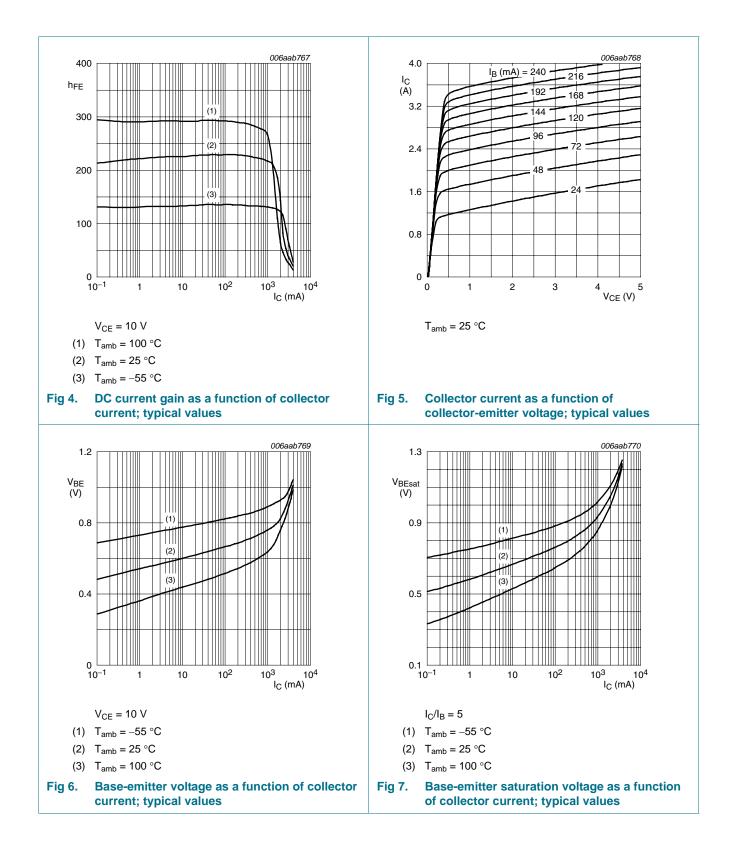
Symbol	Parameter	Conditions	Ν	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = 120 \text{ V}; I_E = 0 \text{ A}$	-		-	100	nA
	current	$V_{CB} = 120 \text{ V}; \text{ I}_{E} = 0 \text{ A};$ T _j = 150 °C	-		-	10	μA
I _{CES}	collector-emitter cut-off current	V_{CE} = 120 V; V_{BE} = 0 V	-		-	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 4 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-		-	100	nA
h _{FE}	DC current gain	V _{CE} = 10 V					
		I _C = 100 mA	[<u>1</u>] 1	00	240	-	
		I _C = 1 A	[<u>1]</u> 1	00	230	-	
		I _C = 1.5 A	[<u>1]</u> g	90	210	-	
		I _C = 2 A	[<u>1]</u> 5	55	130	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 20 \text{ mA}$	<u>[1]</u> -		15	30	mV
		I _C = 1 A; I _B = 200 mA	<u>[1]</u> -		90	170	mV
		I _C = 1.5 A; I _B = 300 mA	<u>[1]</u> -		130	220	mV
		I _C = 2 A; I _B = 400 mA	<u>[1]</u> -		170	280	mV
R _{CEsat}	collector-emitter saturation resistance	$I_{C} = 2 \text{ A}; I_{B} = 400 \text{ mA}$	<u>[1]</u> -		85	140	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_{\rm C}$ = 2 A; $I_{\rm B}$ = 400 mA	<u>[1]</u> -		1.0	1.2	V
t _d	delay time	$V_{CC} = 6 \text{ V}; \text{ I}_{C} = 0.5 \text{ A};$	-		20	-	ns
t _r	rise time	$I_{Bon} = 0.1 \text{ A}; I_{Boff} = -0.1 \text{ A}$	-		280	-	ns
t _{on}	turn-on time		-		300	-	ns
t _s	storage time		-		2165	-	ns
t _f	fall time		-		275	-	ns
t _{off}	turn-off time		-		2440	-	ns
f _T	transition frequency	V _{CE} = 10 V; I _E = 10 mA; f = 100 MHz	-		33	-	MHz
C _c	collector capacitance	$V_{CB} = 20 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz	-		17	-	pF
C _e	emitter capacitance	$V_{EB} = 0.5 \text{ V}; I_C = i_c = 0 \text{ A};$ f = 1 MHz	-		500	-	pF

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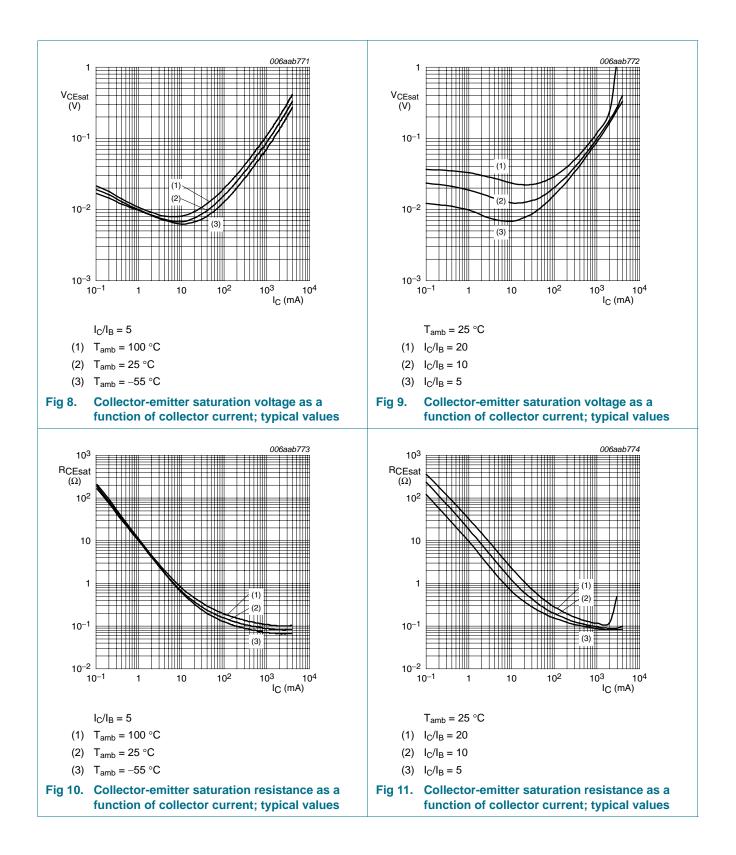




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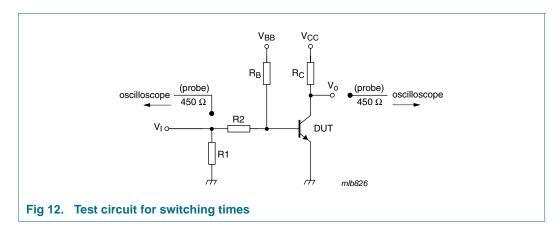
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150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor



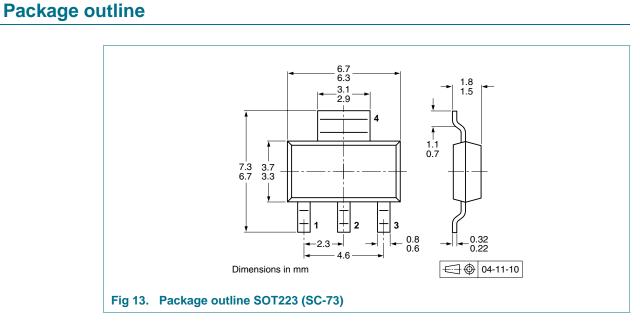
150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.



10. Packing information

Table 8.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.

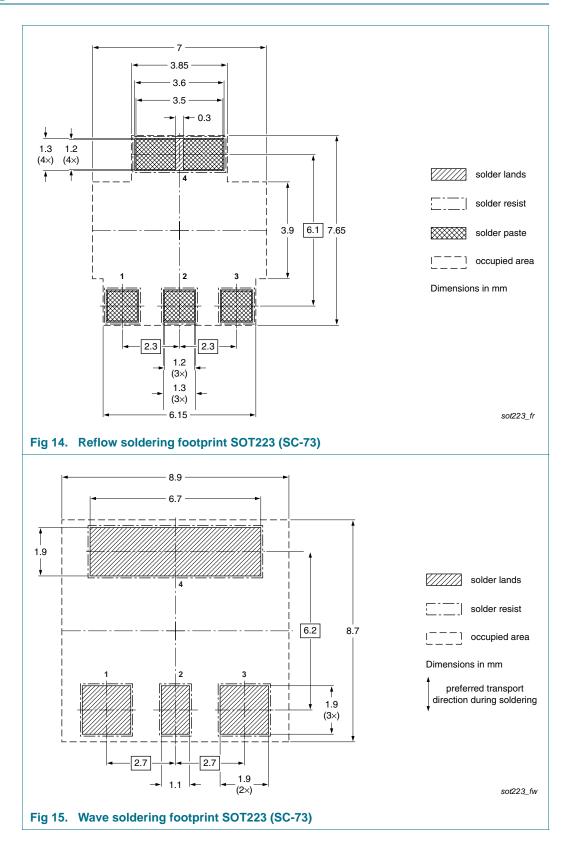
Type number	Package	Description	Packing q	uantity
			1000	4000
PBHV8215Z	SOT223	8 mm pitch, 12 mm tape and reel	-115	-135

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

9.

150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

11. Soldering



PBHV8215Z_1

150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

12. Revision history

Table 9. Re	9. Revision history				
Document ID	1	Release date	Data sheet status	Change notice	Supersedes
PBHV8215Z_	1	20091111	Product data sheet	-	-

150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

13. Legal information

Data sheet status 13.1

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

The term 'short data sheet' is explained in section "Definitions". [2]

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PBHV8215Z 1

NXP Semiconductors

PBHV8215Z

150 V, 2 A NPN high-voltage low V_{CEsat} (BISS) transistor

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